COMPLIANT

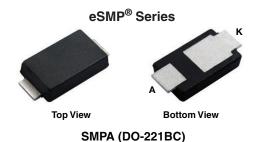
HALOGEN

FREE



# Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



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## **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	5.0 A		
$V_{RRM}$	200 V		
I <sub>FSM</sub>	90 A		
$V_F$ at $I_F = 5.0$ A $(T_A = 125  ^{\circ}C)$	0.69 V		
T <sub>J</sub> max.	175 °C		
Package	SMPA (DO-221BC)		
Circuit configuration	Single		

### **FEATURES**

- · Very low profile typical height of 0.95 mm
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
- Automotive ordering code: P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial and automotive applications.

### **MECHANICAL DATA**

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3\_X - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V5PA22	UNIT	
Device marking code		V522		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	200	V	
Maximum DC forward current	I <sub>F(AV)</sub> (1)	5.0	Α	
	I <sub>F(AV)</sub> (2)	2.3		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	90	А	
Operating junction temperature range	T <sub>J</sub> <sup>(3)</sup>	-40 to +175	°C	
Storage temperature range	T <sub>STG</sub>	-40 to +175	°C	

### Notes

- (1) Mounted on 3 cm x 3 cm copper pad area PCB
- (2) Free air, mounted on recommended copper pad area
- (3) The heat generated must be less than the thermal conductivity from junction-to-ambient: dP<sub>D</sub>/dT<sub>J</sub> < 1/R<sub>θJA</sub>



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)								
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT		
Instantaneous forward voltage	$I_F = 2.5 A$	T <sub>A</sub> = 25 °C	V <sub>E</sub> (1)	0.76	-	V		
	I <sub>F</sub> = 5.0 A			0.82	0.9			
	$I_F = 2.5 A$	T <sub>A</sub> = 125 °C	T. = 125 °C	· ·	VF ("/	0.61	-	ľ
	$I_F = 5.0 \text{ A}$			0.69	0.77			
Reverse current	V 160 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C	I <sub>R</sub> <sup>(2)</sup>	0.001	ı	mA		
	V <sub>R</sub> = 100 V	T <sub>A</sub> = 125 °C		0.3	-			
	V <sub>R</sub> = 200 V	T <sub>A</sub> = 25 °C		-	0.05	IIIA		
		T <sub>A</sub> = 125 °C		0.7	3.0			
Typical junction capacitance	4.0 V, 1 MHz		CJ	240	-	pF		

### Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified)			
PARAMETER	SYMBOL	V5PA22	UNIT
Typical thermal resistance	R <sub>0</sub> JA (1)(2)	100	°C/W
	R <sub>0JM</sub> (3)	5	C/VV

#### Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: dP<sub>D</sub>/dT<sub>J</sub> < 1/R<sub>θ,JA</sub>
- $^{(2)}$  Free air, mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  junction to ambient
- $^{(3)}$  Units mounted on 3 cm x 3 cm aluminum PCB; thermal resistance  $R_{\theta JM}$  junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V5PA22-M3/I	0.032	I	14 000	13" diameter plastic tape and reel	
V5PA22HM3_A/I (1)	0.032	l	14 000	13" diameter plastic tape and reel	

### Note

(1) AEC-Q101 qualified

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise specified)

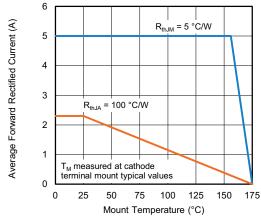


Fig. 1 - Maximum Forward Current Derating Curve

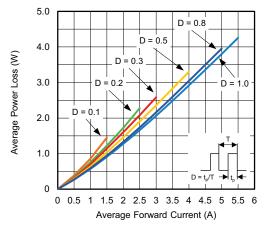


Fig. 2 - Forward Power Loss Characteristics



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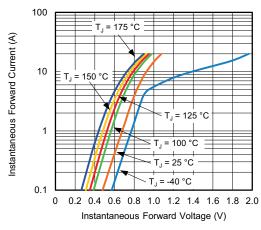


Fig. 3 - Typical Instantaneous Forward Characteristics

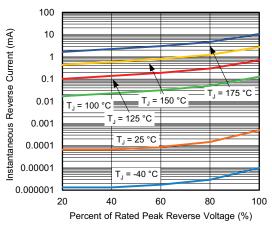


Fig. 4 - Typical Reverse Leakage Characteristics

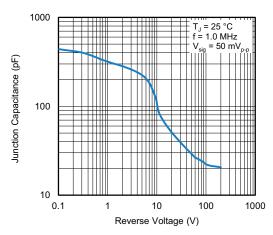


Fig. 5 - Typical Junction Capacitance

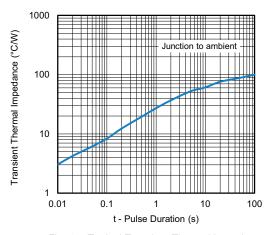


Fig. 6 - Typical Transient Thermal Impedance

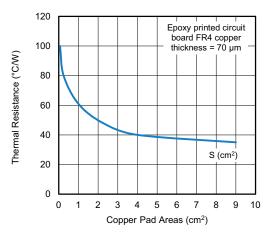


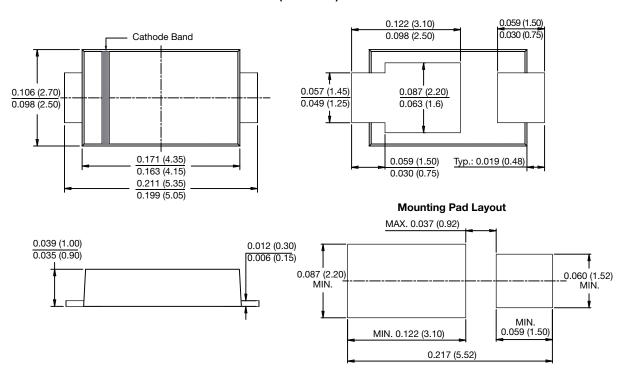
Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas



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## **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

## **SMPA (DO-221BC)**





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